Note Please read rating and ACAUTION (for storage and operating, rating, soldering and mounting, handling) in this PDF catalog to prevent smoking and/or burning, etc.

This catalog has only typical specifications. Therefore, you are requested to approve our product specification or to transact the approval sheet for product specification before ordering

P05E11.pdf 02.9.2

Ceramic Filters (CERAFIL $^{\circledR}$)/Ceramic Discriminators for Communications Equipment



kHz Type Ceramic Discriminators

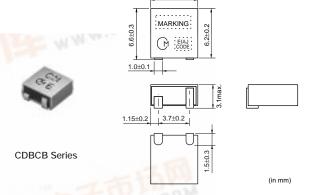
Ceramic discriminator consists of wide band piezoelectric resonator.

It is ideal for mobile communication equipments due to its small size and light weight.

Standard line include products for wide range of application, from cordless telecom to cellular telephone, making non-adjustment and shrinking of the detection circuit possible.

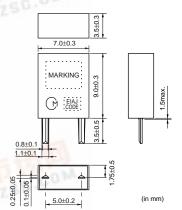
■ Features

- 1. Small in size and light weight.
- 2. Realize no-adjustment in detection circuit.
- 3. High sensitivity and stability.
- 4. Wide range of standard products are available for various ICs.
- 5. Operating temperature range: -20 to +80 (degree C)
 Storage temperature range: -40 to +85 (degree C)



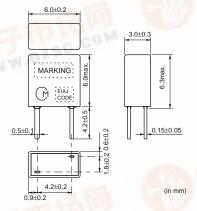


CDBLA Series



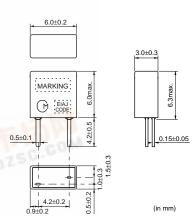


CDBLB_CAX Series





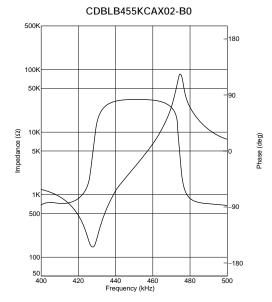
CDBLB_CAY Series

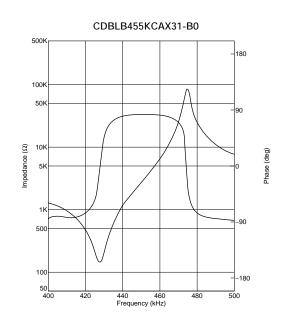


Specified by Impedance Characteristics 1

| A 100 A | | | | | | | |
|---|---|-----------------------------------|-----------------------------------|--------------------|---------|----------|---------|
| Part Number | Nominal Center Frequency (fn) (kHz) | Inclination of Impedance Curve(1) | Inclination of Impedance Curve(2) | Capacitance (C) | IC | IC Maker | Туре |
| CDBLB455KCAX02-B0 | 455 | 447.0±1.5kHz (at Z =2.05kohm) | 463.0±1.5kHz (at Z =10.0kohm) | 140pF±20% | TA8104F | TOSHIBA | PLASTIC |
| CDBLB455KCAX31-B0 | 455 | 447.0±1.5kHz (at Z =2.05kohm) | 463.0±1.5kHz (at Z =10.0kohm) | 140pF±20% | TA31141 | TOSHIBA | PLASTIC |

■ Impedance Curve Specification 1





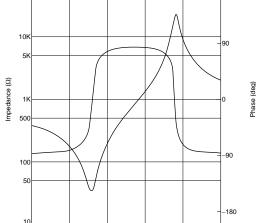
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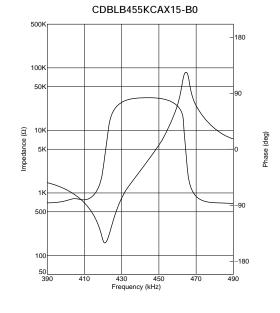
Specified by Impedance Characteristics 2

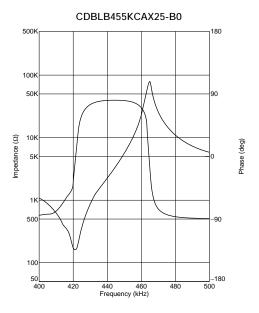
| Part Number | Nominal Center Frequency (fn) (kHz) | Anti-resonant Frequency (Fa) | Delta F (Fa-Fr) | Resonant Capacitance Resistance (R) (C) | | IC | IC Maker | Туре |
|-------------------|---|---------------------------------|--------------------|---|-----------|----------|----------|---------|
| CDBCB455KCAX33-R0 | - | 458.0±1.5kHz | 42±4.0kHz | 300ohm max. | 280pF±20% | CXA1474 | SONY | SMD |
| CDBLA455KCAY03-B0 | - | 455.0±1.5kHz | 48±5.0kHz | 70ohm max. | 600pF±20% | CXA1184 | SONY | PLASTIC |
| CDBLB455KCAY03-B0 | - | 455.0±1.5kHz | 46±5.0kHz | 70ohm max. | 550pF±20% | CXA1184M | SONY | PLASTIC |
| CDBLB455KCAX15-B0 | - | 463.5±1.0kHz | 43±2.0kHz | 300ohm max. | 140pF±20% | CXA1183M | SONY | PLASTIC |
| CDBLB455KCAX25-B0 | 455 | 465.0±1.5kHz | 45±4.0kHz | 300ohm max. | 135pF±20% | CXA1484 | SONY | PLASTIC |
| CDBLB455KCAX33-B0 | 455 | 465.0±1.5kHz | 45±4.0kHz | 300ohm max. | 135pF±20% | CXA1474 | SONY | PLASTIC |

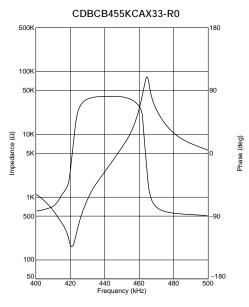
■ Impedance Curve Specification 2

CDBLA/CDBLB455KCAY03-B0







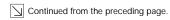


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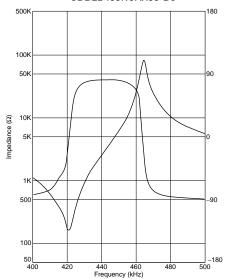
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■ Impedance Curve Specification 2

CDBLB455KCAX33-B0





Specified by Recovered Audio Characteristics

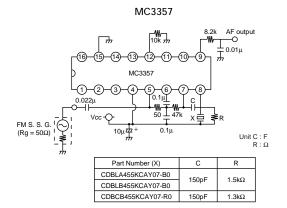
| Part Number | Nominal Center Frequency (fn) (kHz) | Recovered Audio 3dB BW (kHz) | Recovered Audio Output (mV) | Distortion (at fn) (%) | Distortion (%) | IC | IC Maker | Туре |
|--------------------|---|------------------------------------|-----------------------------------|------------------------------|---------------------------------|-------------------------|----------|---------|
| CDBCB455KCAY07-R0 | 455 | fn±4.0 min. | 350 ±60 | 3.0 max. | - | MC3357 | MOTOROLA | SMD |
| CDBCB455KCAY09-R0 | 455 | fn±4.0 min. | 120 ±40 | 1.5 max. | - | NE604N | PHILIPS | SMD |
| CDBCB455KCAY13-R0 | 455 | fn±4.0 min. | 330 ±50 | 4.0 max. | - | CXA1003BM | SONY | SMD |
| CDBCB455KCAY16-R0 | 455 | fn±4.0 min. | 175 ±40 | 2.0 max. | - | MC3372 | MOTOROLA | SMD |
| CDBCB455KCAY21-R0 | 455 | fn±4.0 min. | 55 ±20 | 2.0 max. | - | TA31132 | TOSHIBA | SMD |
| CDBCB455KCAY24-R0 | 455 | fn±4.0 min. | 100 ±40 | 2.0 max. | - | TA31136 | TOSHIBA | SMD |
| CDBCB455KCAY27-R0 | 455 | fn±4.0 min. | 90 ±30 | 2.0 max. | - | TK10487 | токо | SMD |
| CDBCB455KCAY28-R0 | 455 | fn±4.0 min. | 40 ±20 | 3.0 max. | - | TA31142F | TOSHIBA | SMD |
| CDBCB455KCAY29-R0 | 455 | fn±4.0 min. | 100 ±30 | 2.5 max. | - | NE605 | PHILIPS | SMD |
| CDBCB455KCAY32-R0 | 455 | fn±4.0 min. | 40 ±20 | 3.0 max. | - | TA31143 | TOSHIBA | SMD |
| CDBCB455KCAY35-R0 | 455 | fn±4.0 min. | 100 ±40 | 2.5 max. | - | TK10930 | ТОКО | SMD |
| CDBCB455KCAY40-R0 | 455 | fn±4.0 min. | 40 ±20 | 3.5 max. | - | TA31145 | TOSHIBA | SMD |
| CDBCB455KCAY49-R0 | 455 | fn±4.0 min. | 45 ±10 | 3.0 max. | - | MC3361 | MOTOROLA | SMD |
| CDBCB455KCAY50-R0 | 455 | fn±4.0 min. | 64 ±6.4 | 4.0 max. | - | CXA3117N | SONY | SMD |
| CDBCB455KCLX36-R0 | 455 | fn±13.0 min. | 90 ±30 | 2.5 max. | 5.0 max. [within fn ±6kHz] | NE(SA)606 /NE(SA)616 | PHILIPS | SMD |
| CDBCB455KCLX39-R0 | 455 | fn±11.0 min. | 130 ±20 | 2.5 max. | 7.0 max. [within fn ±8kHz] | NE607 /NE617 | PHILIPS | SMD |
| CDBCB455KCLY13-R0 | 455 | fn±13.0 min. | 120 ±30 | 1.5 max. | 5.0 max. [within fn ±8kHz] | CXA1003BM | SONY | SMD |
| CDBCB455KCLY21-R0 | 455 | fn±11.0 min. | 75 ±25 | 2.5 max. | 5.0 max. [within fn ±5.5kHz] | TA31132 | TOSHIBA | SMD |
| CDBLA455KCAY07-B0 | 455 | fn±4.0 min. | 340 ±60 | 2.5 max. | - | MC3357 | MOTOROLA | PLASTIC |
| CDBLA455KCAY09-B0 | 455 | fn±5.0 min. | 100 min. | 1.5 max. | - | NE604N | PHILIPS | PLASTIC |
| CDBLA455KCAY13A-B0 | 455 | fn±4.0 min. | 350 ±50 | 3.0 max. | - | CXA1003BM | SONY | PLASTIC |
| CDBLA455KCAY16-B0 | 455 | fn±4.0 min. | 185 ±40 | 2.0 max. | - | MC3372 | MOTOROLA | PLASTIC |
| CDBLA455KCAY24-B0 | 455 | fn±4.0 min. | 100 ±40 | 2.0 max. | - | TA31136 | TOSHIBA | PLASTIC |
| CDBLA455KCAY28-B0 | 455 | fn±4.0 min. | 40 ±20 | 3.0 max. | - | TA31142 | TOSHIBA | PLASTIC |
| CDBLA455KCAY34-B0 | 455 | fn±4.0 min. | 65 ±20 | 2.5 max. | - | MC13136 | MOTOROLA | PLASTIC |
| CDBLA455KCLY09-B0 | 455 | fn±15.0 min. | 70 ±20 | 1.5 max. | 3.5 max. [within fn ±8kHz] | NE604N | PHILIPS | PLASTIC |
| CDBLA455KCLY13-B0 | 455 | fn±15.0 min. | 110 ±30 | 1.5 max. | 5.0 max. [within fn ±8kHz] | CXA1003BM | SONY | PLASTIC |

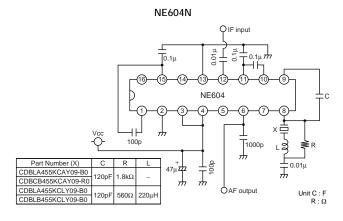
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|------------------------------------|---|------------------------------------|-----------------------------------|------------------------------|-------------------------------|---------------------|----------|---------|
| Part Number | Nominal Center Frequency (fn) (kHz) | Recovered Audio 3dB BW (kHz) | Recovered Audio Output (mV) | Distortion (at fn) (%) | Distortion (%) | IC | IC Maker | Туре |
| CDBLB455KCAY07-B0 | 455 | fn±4.0 min. | 340 ±60 | 3.0 max. | - | MC3357 | MOTOROLA | PLASTIC |
| CDBLB455KCAY13A-B0 | 455 | fn±4.0 min. | 350 ±50 | 3.0 max. | - | CXA1003BM | SONY | PLASTIC |
| CDBLB455KCAY21-B0 | 455 | fn±4.0 min. | 55 ±20 | 2.0 max. | - | TA31132 | TOSHIBA | PLASTIC |
| CDBLB455KCAY24-B0 | 455 | fn±4.0 min. | 100 ±40 | 2.0 max. | - | TA31136 | TOSHIBA | PLASTIC |
| CDBLB455KCAY28-B0 | 455 | fn±4.0 min. | 40 ±20 | 3.0 max. | - | TA31142FN | TOSHIBA | PLASTIC |
| CDBLB455KCAY32-B0 | 455 | fn±4.0 min. | 40 ±20 | 3.0 max. | - | TA31143 | TOSHIBA | PLASTIC |
| CDBLB455KCAY34-B0 | 455 | fn±4.0 min. | 65 ±20 | 2.5 max. | - | MC13136 | MOTOROLA | PLASTIC |
| CDBLB455KCAY40-B0 | 455 | fn±4.0 min. | 40 ±20 | 3.0 max. | - | TA31145 | TOSHIBA | PLASTIC |
| CDBLB455KCAY42-B0 | 455 | fn±4.0 min. | 40 ±15 | 3.0 max. | - | TK14590 /TK14591 | токо | PLASTIC |
| CDBLB455KCAY49-B0 | 455 | fn±4.0 min. | 45 ±10 | 3.0 max. | - | MC3361 | MOTOROLA | PLASTIC |
| CDBLB455KCAY50-B0 | 455 | fn±4.0 min. | 64 ±6.4 | 4.0 max. | - | CXA3117N | SONY | PLASTIC |
| CDBLB455KCLY09-B0 | 455 | fn±15.0 min. | 70 ±20 | 1.5 max. | 3.5 max. [within fn ±8kHz] | NE604N | PHILIPS | PLASTIC |
| CDBLB455KCLY13-B0 | 455 | fn±15.0 min. | 110 ±30 | 1.5 max. | 5.0 max. [within fn ±8kHz] | CXA1003BM | SONY | PLASTIC |
| CDBLB455KCLY21-B0 | 455 | fn±13.0 min. | 65 ±20 | 2.5 max. | 5.0 max. [within fn ±8kHz] | TA31132 | TOSHIBA | PLASTIC |
| CDBLB455KCAX16-B0 | 455 | fn±4.0 min. | 185 ±40 | 2.0 max. | - | MC3372 | MOTOROLA | PLASTIC |
| CDBLB455KCAX18-B0 | 455 | fn±3.0 min. | 180 ±40 | 2.0 max. | - | MC3371 | MOTOROLA | PLASTIC |
| CDBLB455KCAX36-B0 | 455 | fn±3.5 min. | 100 ±25 | 3.5 max. | - | NE606 /616 | PHILIPS | PLASTIC |

■ Test Circuit

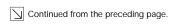




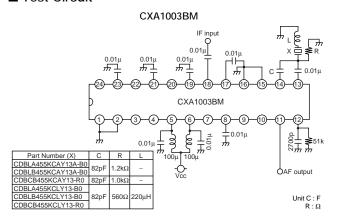
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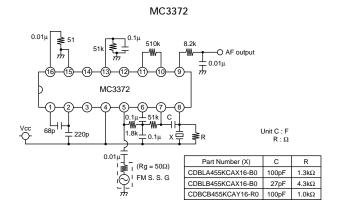


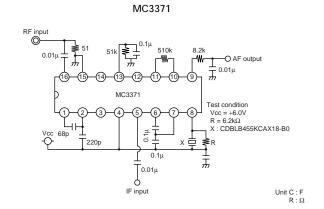


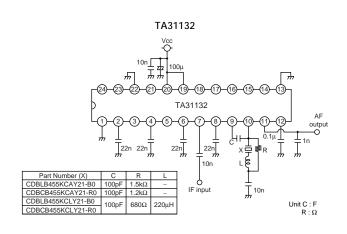


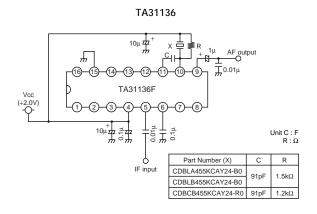
■ Test Circuit

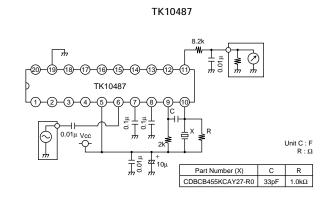


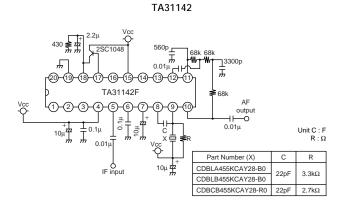


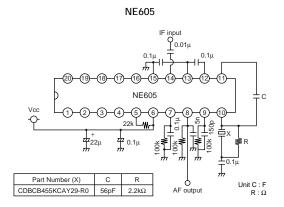








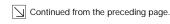




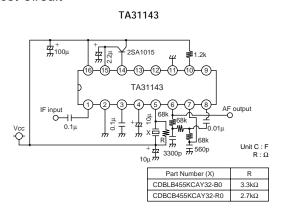
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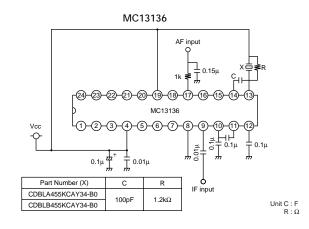
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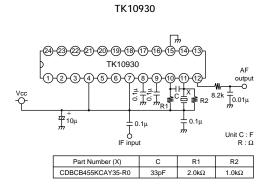
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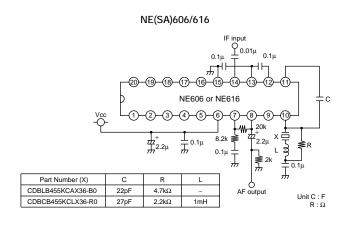


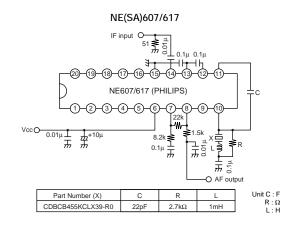
■ Test Circuit

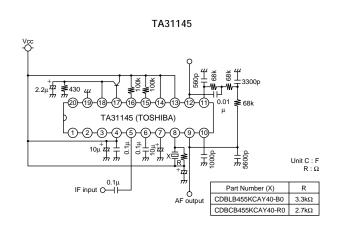


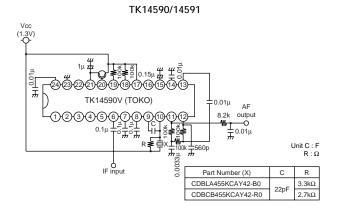


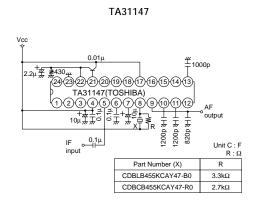




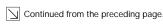






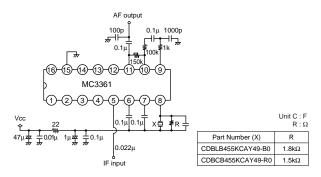


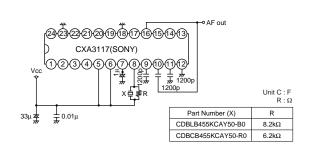
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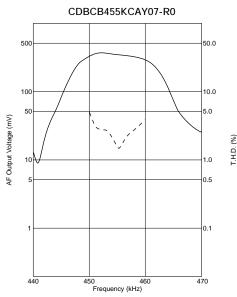
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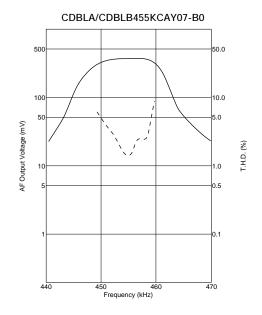


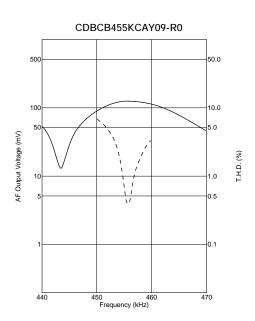


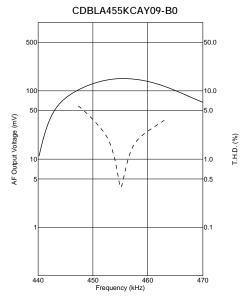


■ Recovered Audio Curve Specification





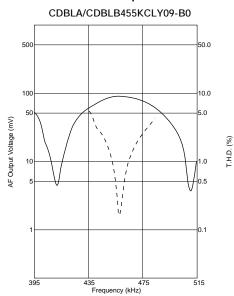


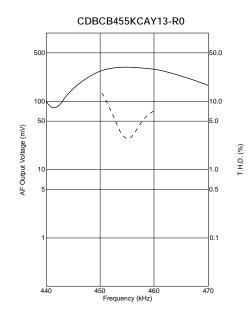


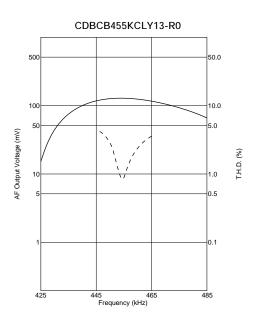
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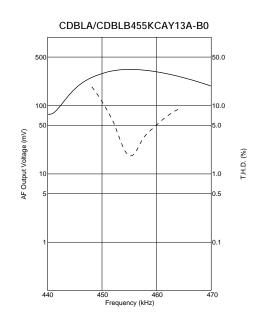
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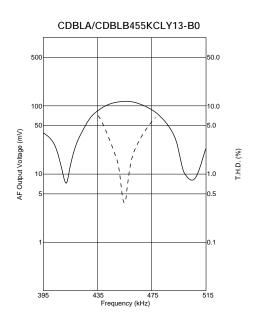
■ Recovered Audio Curve Specification

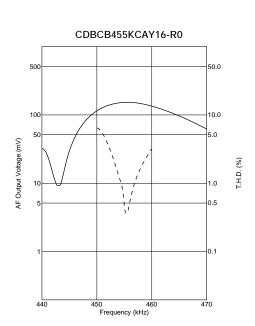




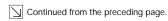




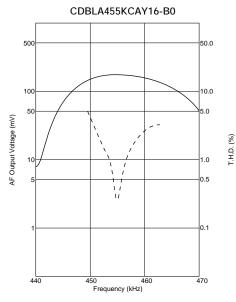


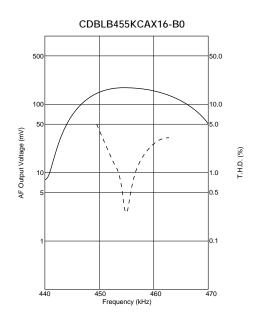


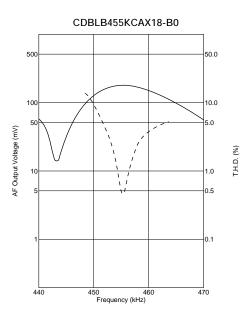
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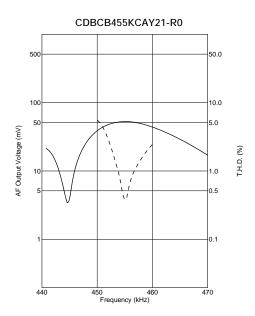


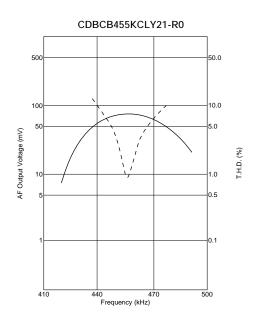
■ Recovered Audio Curve Specification

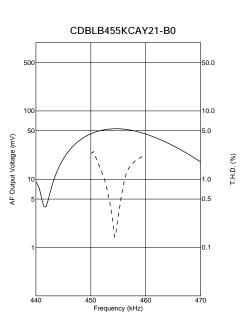












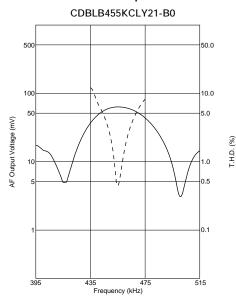
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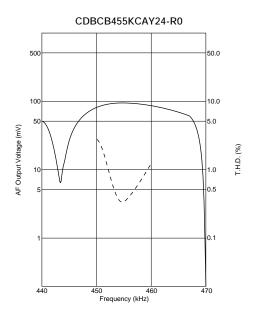
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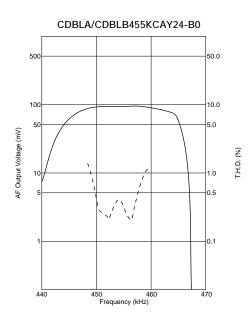
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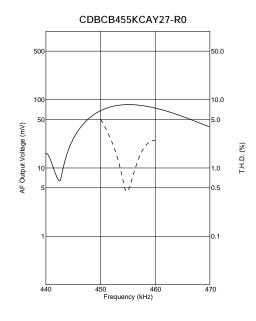
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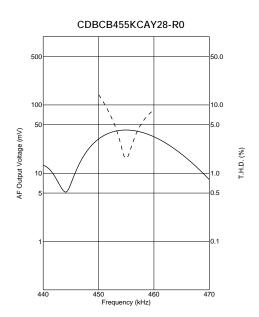
■ Recovered Audio Curve Specification

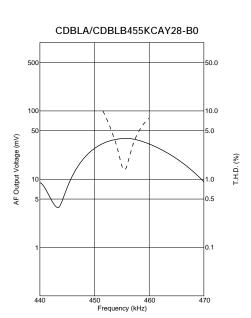








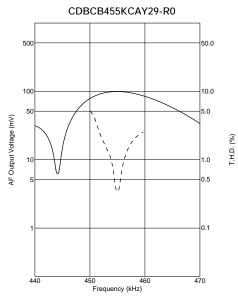


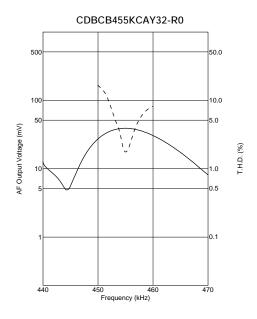


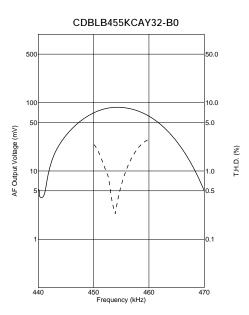
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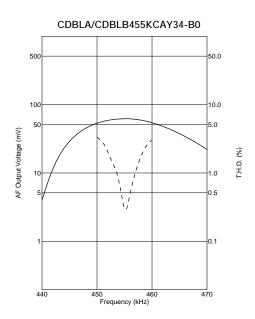


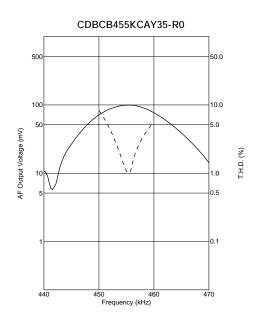
■ Recovered Audio Curve Specification

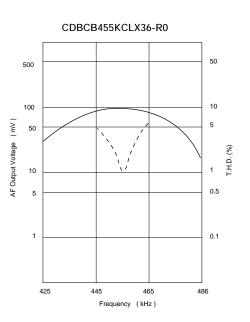








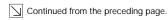




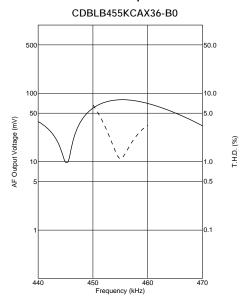
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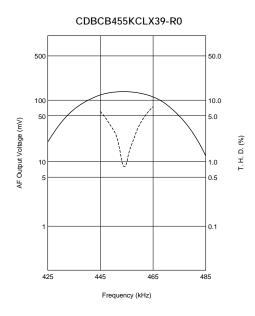
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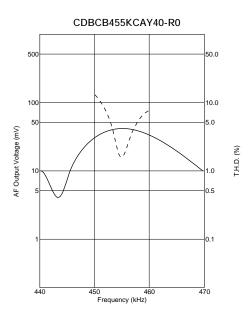
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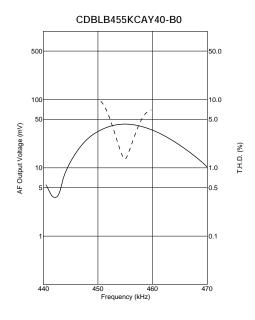


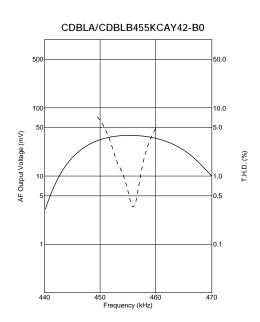
■ Recovered Audio Curve Specification

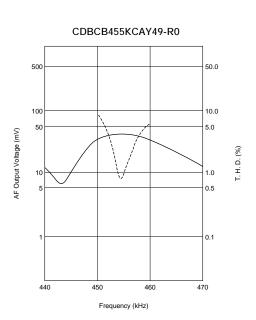










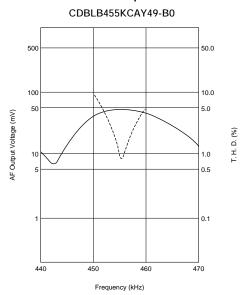


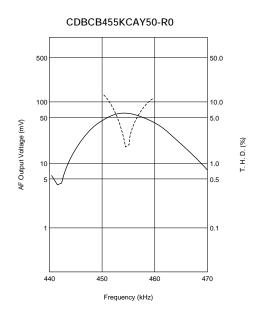
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■ Recovered Audio Curve Specification





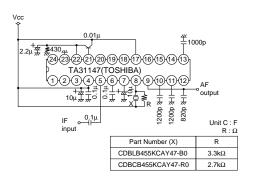
CDBLB455KCAY50-B0 500 100 500 100 500 100 500 100 500 100 500 100 500 100 500 100 500 100 500 100 500 100 500 100 500 100 500 100 500 100 500 100 500 100 500 100 Frequency (kHz)

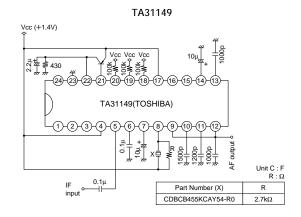
Specified by S Curve Characteristics

| Part Number | Nominal Center Frequency (fn) (kHz) | | S Curve (2) at fn±4.8kHz (mV) | IC | IC Maker | Туре |
|-------------------|---|---------|-------------------------------------|---------|----------|---------|
| CDBCB455KCAY47-R0 | 455 | 130 ±20 | 150 ±15 | TA31147 | TOSHIBA | SMD |
| CDBCB455KCAY54-R0 | 455 | 165 ±20 | 170 ±20 | TA31149 | TOSHIBA | SMD |
| CDBLB455KCAY47-B0 | 455 | 140 ±20 | 150 ±15 | TA31147 | TOSHIBA | PLASTIC |

■ Test Circuit

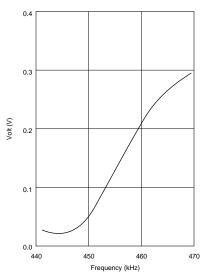


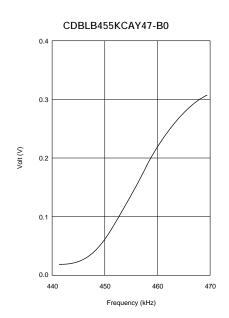




■ S Curve Specification

CDBCB455KCAY47-R0





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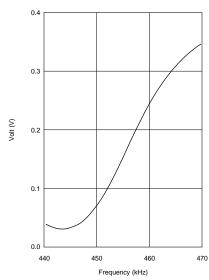




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■ S Curve Specification

CDBCB455KCAY54-R0



no 88

Ceramic Discriminators Notice

■ CDBCB Series Notice (Soldering and Mounting)

1. Standard Reflow Soldering Condition

(1) Reflow

Filter is soldered one time within the following temperature condition and then being placed in natural condition for 24 hours.

(2) Soldering Iron

Electrode is directly with the tip of soldering iron of +350 ±5°C for 3±1 seconds, and then being placed in natural condition for 24hours.

2. Wash

(1) Cleaning Solvent

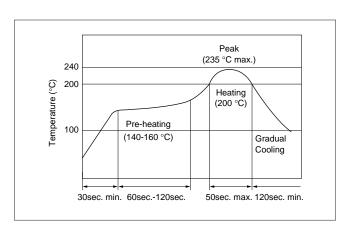
CFC alternatives(HCFC Series), Isopropyl Alcohol(IPA), Water(Demineralized Water), Cleaning Water Solution(Cleanthrough-750H,Pine Alha 100S), Silicon(Technocare FRW)

(2) Cleaning Conditions

- Immersion Wash
 - 2 minutes max. in above solvent at +60°C max.
- Shower or Rinse Wash
 - 2 minutes max. in above solvent at +60°C max.

(3) Notice

- When components are immersed in solvent, be sure to maintain the temperature of components below the temperature of solvent.
- Please do not use ultrasonic cleaning.
- Total washing time should be within 4minutes.
- Please ensure the component is thoroughly evaluated in your application circuit.
- Please do not use chlorine, petroleum and alkali cleaning solvent.
- If you plan to use any other type of solvents, please consult with Murata or MUrata representative prior to using.



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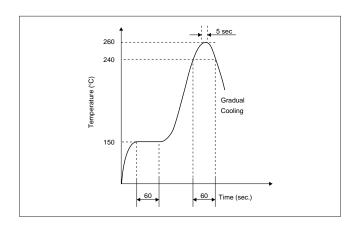




Ceramic Discriminators Notice

() Continued from the preceding page.

- CDSCA Series Notice (Soldering and Mounting)
- 1. Standard Reflow Soldering Condition
- (1) Reflow



- (2) Soldering Iron
 Lead terminal is directly contacted with the tip of soldering iron of +280±5°C for 3.0 seconds±0.5 seconds.
- 2. Wash

The component cannot be withstand washing.



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Ceramic Discriminators Notice

■ CDBCB Series Notice (Handling)

- 1. The component will be damaged when an excessive stress is applied.
- 2. In the case that the component is cleaned, confirm no reliability degradation is created.
- In case of covering filter with over coat, conditions such as material of resin, cure temperature, and so on should be evaluated well.
- 4. Do not use strong acidity flux, more than 0.2wt% chlorine content, in re-flow soldering.
- CDBLA/CDBLB Series Notice (Handling)
- 1. Do not use this product with bend. The component may be damaged if excess mechanical stress is applied to it mounted on the printed circuit board.
- 2. The component will be damaged when an excessive stress is applied.
- All kinds of re-flow soldering must not be applied on the component.
- CDSCA Series Notice (Handling)
- 1. The component mounted on the PCB may be damaged if excess mechanical stress is applied.
- 2. Layout the components on the PCB to minimize the stress imposed by the warp or flexure of the board.
- After installing components, if solder is excessively applied to the circuit board, mechanical stress will cause destruction resistance characteristics to be lower. To prevent this, be extremely careful in determining shape and dimension before designing the circuit board diagram.
- 4. When the positioning claw or pick up nozzle are worn, the excess load is applied to the components while positioning or placing are performed. Careful checking and maintenance are necessary to prevent unexpected trouble.
- 5. When correcting component's position with a soldering iron, the tip of the soldering iron should not directly touch the chip component. Depending on the soldering conditions, the effective area of terminations may be reduced. The use of solder containing Ag should be considerd to prevent the electrode erosion.
- 6. Do not clean or wash the component as it is not hermetically sealed.
- 7. In case of overcoating the part, coating conditions such as material, curing temperature, and so on must be evaluated deeply.
- Accurate test circuit values are required to measure electrical characteristics.
 It may be a cause of mis-correlation if there is any deviation, especially stray capacitance, from the test circuit in the specification.

 The product, packed in the moisture-proof bag (dry pack), is sensitive to moisture.
 The following treatment is required before applying re-flow soldering, to avoid package cracks or reliability degradation caused by thermal stress.

When unpacked, store the component in an atmosphere

of below 25C. and below 65%R.H., and solder within

4. Do not clean or wash the component as it is not hermetically sealed.

48 hours.

- Do not use strong acidity flux, more than 0.2wt% chlorine content, in flow soldering.
- In case of covering discriminator with over coat, conditions such as material of resin, cure emperature, and so on should be evaluated well.

